



MT3337 GPS All-in-One Solution Data Sheet

Version: 1.02
Release date: 2013-01-14

© 2008 - 2013- 2009 MediaTek Inc.

This document contains information that is proprietary to MediaTek Inc.

Unauthorized reproduction or disclosure of this information in whole or in part is strictly prohibited.

Specifications are subject to change without notice.

Document Revision History

Revision	Date	Author	Description
1.00	2012/07/19	Loris Li	Formal release
1.01	2012/11/05	Loris Li	Remove UART MEIF
1.02	2013/01/14	Loris Li	Correct clock support related description

Table of Contents

Document Revision History	2
Table of Contents	3
1 System Overview.....	5
1.1 General descriptions.....	5
1.2 Features.....	6
2 Pin Assignment and Descriptions	7
2.1 Pin assignment (top view)	7
2.2 Pin descriptions	7
3 Block Diagrams	11
3.1 Architecture of single-chip receiver	11
3.2 Functional block diagram (RF part)	11
4 MT3337 RF Part	12
4.1 LNA/Mixer	12
4.2 VCO/Synthesizer	12
4.3 IF CSF	12
4.4 PGA	12
4.5 ADC	12
5 MT3337 Digital Part	13
5.1 ARM7EJ-S	13
5.2 Battery backed-up memory	13
5.3 SMPS.....	14
5.4 Timer function	14
5.5 GPIO in RTC domain.....	14
5.6 Low power detection.....	14
5.7 Clock module	15
5.8 Reset controller	15
5.9 Host interface.....	16
5.9.1 UART	16
5.10 Interrupt control unit.....	16
5.11 EFUSE	16
5.12 GPIO unit	16
5.13 PPS.....	16
5.14 Power scheme	16
6 Electrical Characteristics	20
6.1 DC characteristics	20
6.1.1 Absolute maximum ratings.....	20
6.1.2 Recommended operating conditions	20
6.1.3 General DC characteristics	21
6.1.4 DC electrical characteristics for 2.8 volts operation.....	21

6.1.5	DC electrical characteristics for 1.8 volts operation.....	21
6.1.6	DC electrical characteristics for 1.2 volts operation (for TIMER and 32K_OUT)....	21
6.2	Analog related characteristics	22
6.2.1	SMPS DC characteristics.....	22
6.2.2	TCXO LDO DC characteristics	22
6.2.3	TCXO SWITCH DC characteristics	22
6.2.4	1.2 volts core LDO DC characteristics.....	23
6.2.5	1.2 volts RTC LDO DC characteristics	23
6.2.6	32 KHz crystal oscillator (XOSC32).....	23
6.3	RF related characteristics.....	23
6.3.1	DC electrical characteristics for RF part	23
6.3.2	RX chain from LNA to PGA, before ADC.....	24
6.3.3	Receiver front-end part (LNA only)	24
6.3.4	Mixer and channel selection filter (CSF).....	24
6.3.5	Programmable gain amplifier (PGA).....	25
6.3.6	2-bit and 4-bit quantizer (ADC)	25
6.3.7	Integrated synthesizer.....	25
6.3.8	Crystal oscillator (XO).....	25
7	Interface Characteristics	26
7.1	JTAG interface timing	26
7.2	RS-232 interface timing	26
8	Package Description	28
8.1	Top mark.....	28
8.2	Package dimensions	29

Lists of Figures

Figure 3-1:	MT3337 system block diagram.....	11
Figure 3-2:	MT3337 RF functional block diagram.....	11
Figure 5-1:	RTC with internal RTC LDO application circuit 1.....	13
Figure 5-2:	RTC with internal RTC LDO application circuit 2.....	14
Figure 5-3:	Power on reset diagram	15
Figure 5-4:	Power on/off reset behavior.....	15
Figure 5-5:	Power supply connection (low power).....	17
Figure 5-6:	Power supply connection (low cost)	18
Figure 5-7:	Power supply connection (external LDO).....	18
Figure 5-8:	Power on/off sequence for external LDO mode	19
Figure 7-1:	Timing diagram of JTAG interface	26
Figure 7-2:	Timing diagram of RS-232 interface.....	27

1 System Overview

1.1 General descriptions

MT3337 is a high-performance single-chip GPS solution which includes on-chip CMOS RF, digital baseband, and ARM7 CPU. It is able to achieve the industry's highest level of sensitivity, accuracy and Time-to-First-Fix (TTFF) with the lowest power consumption in a small-footprint lead-free package. Its small footprint and minimal BOM requirement provide significant reductions in the design, manufacturing and testing resource required for portable applications.

With built-in LNA to reach total NF to 2.2 dB, you can eliminate antenna requirement and do not need external LNA. With its on-chip image-rejection mixer, the spec of external SAW filter is alleviated. With an on-chip automatic center frequency calibration band pass filter, an external filter is not required. The on-chip power management design allows MT3337 to be easily integrated into your system without extra voltage regulator. With both linear and a highly efficient switching type regulator embedded, MT3337 allows direct battery connection and does not need any external LDO, which gives customers plenty of choices for the application circuit.

Up to 12 multi-tone active interference cancellers (ISSCC2011 award) offer you more flexibility in system design. The integrated PLL with Voltage Controlled Oscillator (VCO) provides excellent phase noise performance and fast locking time. A battery backed-up memory and a real-time clock are also provided to accelerate acquisition at the system restart-up.

MT3337 supports up to 210 PRN channels. With 66 search channels and 22 simultaneous tracking channels, MT3337 acquires and tracks satellites in the shortest time even at indoor signal levels. MT3337 supports various location and navigation applications, including autonomous GPS, SBAS ranging (WAAS, EGNOS, GAGAN, and MSAS), QZSS, DGPS (RTCM) and AGPS.

Through MT3337's excellent low-power consumption characteristic (acquisition 25 mW, track 18 mW), while using power sensitive devices, especially portable applications, you will not need to worry about the operating time anymore and can have more fun. Combined with many advanced features including AlwaysLocate™, EPO™, and logger function, MT3337 provides always-on position with minimal average power consumption. The great features provide you supreme experiences for portable applications such as DSC, cellular phone, PMP and gaming devices.

1.2 Features

- Specifications
 - 22 tracking / 66 acquisition-channel GPS receiver
 - Supports up to 210 PRN channels
 - Supports multi-GNSS incl. QZSS, SBAS ranging
 - Supports WAAS/EGNOS/MSAS/GAGAN
 - 12 multi-tone active interference cancellers (ISSCC2011 award)
 - RTCM ready
 - Indoor and outdoor multi-path detection and compensation
 - Supports FCC E911 compliance and A-GPS
 - Max. fixed update rate up to 5 Hz
- Advanced software features
 - AlwaysLocate™ advanced location awareness technology
 - EPO™ orbit prediction
 - Supports logger function
- Reference oscillator
 - TCXO
 - Frequency: 16.368 MHz, 26 MHz
 - Frequency variation: ±2.0 ppm
- RF configuration
 - 4-bit IF signal
 - SoC, integrated in single chip with CMOS process
- ARM7EJ-S CPU
 - Up to 98 MHz processor clock
 - Dynamic clock rate control
- Pulse-per-second (PPS) GPS time reference
 - Adjustable duty cycle
 - Typical accuracy: ±10 ns
- Power scheme
 - A 1.8 volts SMPS build-in SOC
 - Direct lithium battery connection (2.8 ~ 4.3 volts)
 - Self build 1.2 volts RTC LDO, 1.2 volts core LDO, and 2.8 volts TCXO LDO
- Build-in reset controller
 - Does not need of external reset control IC
- Internal real-time clock (RTC)
 - 32.768 KHz ± 20 ppm crystal
 - Timer pin for external device on/off control
 - 1.2 volts RTC clock output
- Serial interface
 - UART : 4800/9600/38400/115200 bps
 - GPIO interface (up to 16 pins)
- NMEA
 - NMEA 0183 standard V3.01 and backward compliance
 - Supports 219 different data
- Superior sensitivities
 - Acquisition: -148 dBm (cold) / -163 dBm (hot)
 - Tracking: -165 dBm
- Ultra-low power consumption
 - Acquisition: 25 mW
 - Tracking: 18 mW
 - AlwaysLocate™: 3 mW
- Package
 - VFBGA: 4.3 mm x 4.3 mm, 57 balls, 0.5 mm pitch
- Slim hardware design
 - 52 mm² solution footprint with all software features inside
 - 9 passive external components

2 Pin Assignment and Descriptions

2.1 Pin assignment (top view)

	1	2	3	4	5	6	7	8
A	RFIN	AVSS_HF	EXT_R	HRST_B	DVDD_CO RE2	SCS1_	JRST_	NC
B	AVDD_RFC ORE	AVSS_VCO	RFTEST	XTEST	DVDD_IO2	JDO	RX0	TX0
C	AVDD_BGX OTHLS	AVSS_LF	NC	EINT0	EINT1	JMS	EINT2	RX2
D	OSC	AVSS28_TL DO	NC	NC	DVSS_IO2	JRCK	SCK1	EINT3
E	AVDD43_V BAT	AVDD28_C LDO	NC	NC	DVSS_CO RE	JDI	DVSS_IO1	DVDD_IO1
F	VREF	GND_MISC	AVSS12_C LDO	BUCK_FB	DVDD_CO RE1	DVDD_IO3	TX2	FSOURCE _WR
G	AVDD28_T LDO	AVDD28_T LDO_SW	PGND_SM PS	NC	TIMER	32K_OUT	JCK	RX1
H	AVDD12_C LDO	LXBK	AVDD43_S MPS	RTCCLK_O	RTCCLK	AVDD43_R TC	AVDD12_R TC	TX1

2.2 Pin descriptions

Pin#	Symbol	Type	Description
System interface (2 pins)			
A4	HRST_B	2.8V LVTTTL input 75K pull-up, SMT	System reset. Active low.
B4	XTEST	2.8V LVTTTL input 75K pull-down, SMT	Test mode. <i>Must keep low in normal mode.</i>
Peripheral interface (8 pins)			
B7	RX0/ MM_I2CC/H_SPI_SI	2.8V, LVTTTL I/O PPU, PPD, SMT 2mA ~ 16mA PDR	Serial input for UART 0 Default: 75K pull-up Default: 8mA driving
B8	TX0/MM_I2CD/H_SPI_SO	2.8V, LVTTTL I/O PPU, PPD, SMT 2mA ~ 16mA PDR	Serial output for UART 0 Default: 75K pull-up Default: 8mA driving

Pin#	Symbol	Type	Description
G8	RX1/H_SPI_SCK/JCK/CTS0/MM_I2CC/CXO_TSENS/GIO0	2.8V, LVTTTL I/O PPU, PPD, SMT 2mA ~ 16mA PDR	Serial input for UART 1 Default: 75K pull-up Default: 8mA driving
H8	TX1/TXIND/JMS/RTS0/MM_I2CD/CXO_CS/GIO1	2.8V, LVTTTL I/O PPU, PPD, SMT 2mA ~ 16mA PDR	Serial output for UART 1 Default: 75K pull-up Default: 8mA driving
C8	RX2/SPI_SI/JDI/DBG_RX/BSI_CS/EEDO/EE_SDA/GIO2	2.8V, LVTTTL I/O PPU, PPD, SMT 2mA ~ 16mA PDR	Serial input for UART 2 Default: 75K pull-up Default: 8mA driving
F7	TX2/SPI_SO/JDO/DBG_TX/EEDI/GIO3	2.8V, LVTTTL I/O PPU, PPD, SMT 2mA ~ 16mA PDR	Serial output for UART 2 Default: 75K pull-up Default: 8mA driving Strap pin tldo_sw_sel (not supported on ES1/ES2 version IC) 1'b0: AVDD28_TLDO_SW output 1.8V 1'b1: AVDD28_TLDO_SW output 2.8V
D7	SCK1/SPI_SCK/JRCK/EESK/EE_SCL/GIO4	2.8V, LVTTTL I/O PPU, PPD, SMT 2mA ~ 16mA PDR	SPI clock output Default: 75K pull-up Default: 8mA driving Strap pin clk_sel[0] Clk_sel[1:0] Mode 2'b00: reserved 2'b01: External clock mode 2'b10: 26MHz TCXO mode 2'b11: 16.368MHz TCXO mode
A6	SCS1#/SPI_SCS#/BSI_DATA/JRST#/SYNC_PULSE/EE_CS/GIO5	2.8V, LVTTTL I/O PPU, PPD, SMT 2mA ~ 16mA PDR	SPI slave selection 1 Default: 75K pull-up Default: 8mA driving Strap pin clk_sel[1]
Debugging interface (6 pins)			
G7	JCK/BSI_CS/MM_I2CC/ECLK/GIO6	2.8V, LVTTTL I/O PPU, PPD, SMT 2mA ~ 16mA PDR	JTAG interface clock Default: 75K pull-down Default: 8mA driving
C6	JMS/BSI_CS/MM_I2CD/DUTY_CYCLE/PPS/GIO7	2.8V, LVTTTL I/O PPU, PPD, SMT 2mA ~ 16mA PDR	JTAG interface mode selection Default: 75K pull-down Default: 8mA driving
E6	JDI/FRAME_SYNC/DBG_RX/GIO8	2.8V, LVTTTL I/O PPU, PPD, SMT 2mA ~ 16mA PDR	JTAG interface data input. Default: 75K pull-down Default: 8mA driving
B6	JDO/PPS/DBG_TX/GIO9	2.8V, LVTTTL I/O PPU, PPD, SMT 2mA ~ 16mA PDR	JTAG interface data output Default: 75K pull-up Default: 8mA driving Strap pin host_sel[0] Host_sel[1:0] Interface 2'b00: I2C 2'b01: Reserved 2'b10: SPI 2'b11: UART

Pin#	Symbol	Type	Description
D6	JRCK/CXO_CS/GIO10	2.8V, LVTTTL I/O PPU, PPD, SMT 2mA ~ 16mA PDR	JTAG interface return clock Default: 75K pull-up Default: 8mA driving Strap pin host_sel[1]
A7	JRST#/H_SPI_SCS#/CXO_T SENS/SYNC_PULSE/GIO11	2.8V, LVTTTL I/O PPU, PPD, SMT 2mA ~ 16mA PDR	JTAG interface reset Default: 75K pull-up Default: 8mA driving
External system interface (4 pins)			
C4	EINT0/MM_I2CC/BSI_CS/GI O12	2.8V, LVTTTL I/O PPU, PPD, SMT 2mA ~ 16mA PDR	External interrupt 0 Default: 75K pull-down Default: 8mA driving
C5	EINT1/MM_I2CD/PPS/BSI_D ATA/GIO13	2.8V, LVTTTL I/O PPU, PPD, SMT 2mA ~ 16mA PDR	External interrupt 1 Default: 75K pull-down Default: 8mA driving
C7	EINT2/DBG_RX/PPS/GIO14	2.8V, LVTTTL I/O PPU, PPD, SMT 2mA ~ 16mA PDR	External interrupt 2 Default: 75K pull-up Default: 8mA driving
D8	EINT3/DBG_TX/PPS/GIO15	2.8V, LVTTTL I/O PPU, PPD, SMT 2mA ~ 16mA PDR	External interrupt 3 Default: 75K pull-up Default: 8mA driving
RTC interface (6 pins)			
H6	AVDD43_RTC	Analog power	RTC LDO input
H7	AVDD12_RTC	Analog power	RTC LDO output
H5	RTCCLK	Analog input	RTC 32KHz XTAL input
H4	RTCCLK_O	Analog output	RTC 32KHz XTAL output
G6	32K_OUT/DR_IN	1.2V LVTTTL I/O PPU, PPD, SMT 4mA, 8mA, 12mA, 16mA PDR	RTC domain GPIO pin, can be programmed to 32KHz clock output or DR wake-up signal input Default: 75K pull-down Default: 16mA driving
G5	TIMER	1.2V LVTTTL I/O open drain, SMT 4mA, 8mA, 12mA, 16mA PDR	Wake up other devices from RTC. If this pin is not used, tie it to the ground.
RF & analog			
B1	AVDDRF_CORE	RF power	1.8V supply for RF core circuits
A3	EXT_R	Analog	External R connection for R calibration
B3	RFTEST	Analog signal	RF testing signal
B2	AVSS_VCO	RF ground	GND pin for SX VCO
C1	AVDD_BGXOTHLS	RF power	1.8V supply for XTAL OSC, bandgap, Thermal sensor and level shifter
C2	AVSS_LF	RF ground	GND pin for low-frequency circuits
D1	OSC	Analog signal	Input for crystal oscillator or TCXO
A2	AVSS_HF	RF ground	GND pin for high-frequency circuits
A1	RF_IN	RF signal	LNA RF Input pin
F5	DVDD_CORE1	Digital power	Digital 1.2V core power input

Pin#	Symbol	Type	Description
A5	DVDD_CORE2	Digital power	Digital 1.2V core power input
E5	DVSS_CORE	Digital ground	Digital 1.2V core ground
E8	DVDD_IO1	Digital power	Digital 1.8/2.8V IO power input
B5	DVDD_IO2	Digital power	Digital 1.8/2.8V IO power input
F6	DVDD_IO3	Digital power	Digital 1.8/2.8V IO power input
E7	DVSS_IO1	Digital ground	Digital 1.8/2.8V IO ground
D5	DVSS_IO2	Digital ground	Digital 1.8/2.8V IO ground
F8	FSOURCE_WR	Digital power	EFUSE 2.8V write power supply
F1	VREF	Analog	Bandgap output pin. Must add 1uF decoupling cap on EVB.
F2	GND_MISC	Analog ground	GND pin for buck controller
D2	AVSS28_TLDO	Analog ground	GND pin for TCXO LDO and start-up block
E1	AVDD43_VBAT	Analog power	TCXO LDO input pin. Always be powered by external source. UVLO will detect this PIN to check power status.
G2	AVDD28_TLDO_SW	Analog power	TCXO power switch output pin
G1	AVDD28_TLDO	Analog power	TCXO LDO output pin
E2	AVDD28_CLDO	Analog power	Core LDO input pin. Always powered by external source or SMPS
H1	AVDD12_CLDO	Analog power	Core LDO output pin
F3	AVSS12_CLDO	Analog ground	GND pin for core LDO
G3	PGND_SMPS	SMPS	SMPS GND pin
H2	LXBK	SMPS	SMPS output pin
H3	AVDD43_SMPS	SMPS	SMPS input pin.
F4	BUCK_FB	SMPS	SMPS feedback pin

Notes:

PPU = Programmable pull-up
 PPD = Programmable pull-down
 PSR = Programmable slew rate
 PDR = Programmable driving

3 Block Diagrams

3.1 Architecture of single-chip receiver

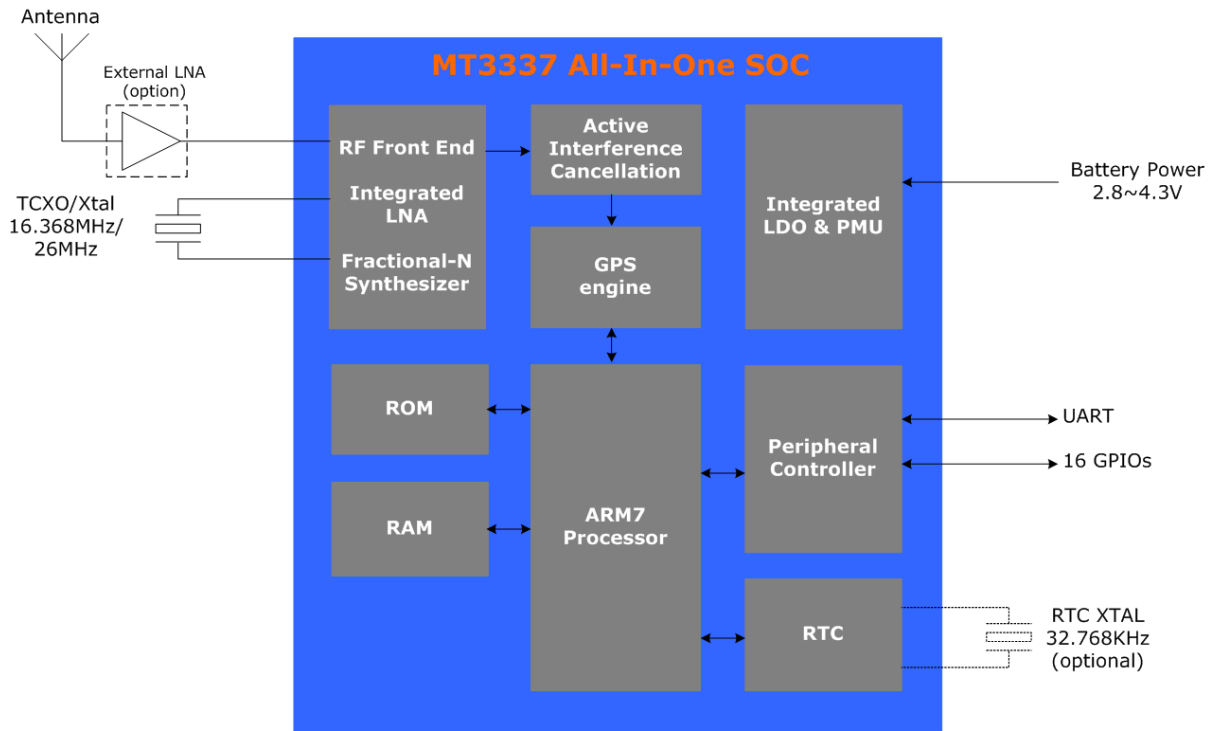


Figure 3-1: MT3337 system block diagram

3.2 Functional block diagram (RF part)

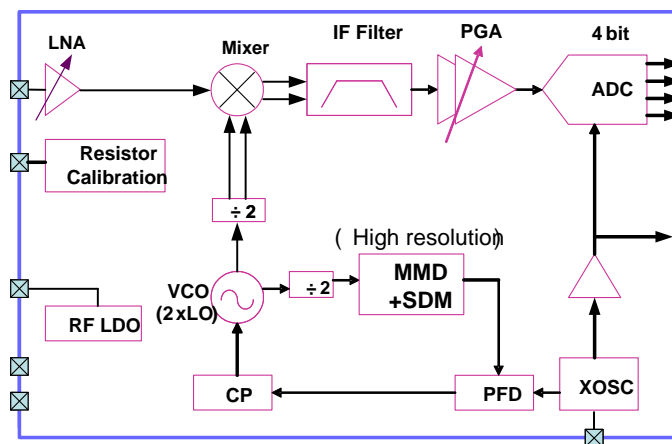


Figure 3-2: MT3337 RF functional block diagram

4 MT3337 RF Part

4.1 LNA/Mixer

Upon receiving RF input signal in through either GPS antenna to internal LNA or external antenna and LNA, the mixer down converts the amplified signal (1575.42 MHz) to a 4.092 MHz differential IF signal. In the application with external LNA, the external LNA gain ranging from 0 to 36 dB is recommended. The down-conversion mixer is single-ended passive mixer with current mode interface between the mixer and complex CSF.

4.2 VCO/Synthesizer

The entire frequency synthesizer includes crystal oscillator, VCO, divider, phase frequency detector (PFD), charge pump (CP) and loop filter which are all integrated on the MT3337 chip. Upon power-on, VCO is auto-calibrated to its required sub-band.

4.3 IF CSF

The down converted IF signal from the mixer output passes through a bandpass CSF. Centered at 4.092 MHz, the filter rejects out-of-band (10 MHz) interferences by more than 20 dB and has a pass band ripple of < 0.5 dB. The current-mode mixer and filter also provide a 32 dB pass band gain together to improve noise figure.

4.4 PGA

The PGA has approximately 40 dB of gain control range with approximately 1.6 dB per step. The maximum gain is around 40 dB. HPF circuits are implemented among PGAs to remove DC offset quickly.

4.5 ADC

The differential IF signal is being quantized by a 4-bit ADC. The sampling clock can be provided from OSC direct path or using LO/96.

5 MT3337 Digital Part

5.1 ARM7EJ-S

The ARM7EJ-S processor provides flexibility necessary for building Java-enabled, real-time embedded devices requiring small size, low-power and high performance. It builds on the features and benefits of the established ARM7TDMI core and is delivered in synthesizable form. ARM7EJ-S is supported by a wide variety of development tools and can run at speeding up to 98 MHz.

ARM7EJ-S includes a JTAG interface which provides a standard development and debugging interface. The interface can connect to a variety of off-the-shelf emulators. The emulators provide single-step, trap and access to all the internal registers of the digital part of MT3337.

5.2 Battery backed-up memory

MT3337 provides very low leakage (about 5 uA in the backup mode) battery backed-up memory, which contains all the necessary GPS information for quick start-up and a small amount of user configuration variables. There is a built-in 1.2 volts LDO for RTC domain and it can be bypassed while an external LDO is applied. The RTC LDO is a voltage regulator having very low quiescent current, and typical quiescent current < 2.5 uA. The small ceramic capacitor can be used as the output capacitor, and the stable operation region ranges from very light load (~=0) to about 3 mA.

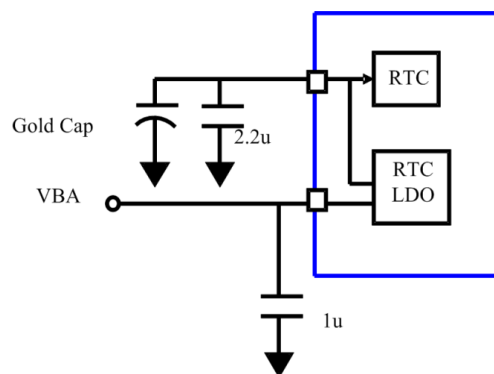


Figure 5-1: RTC with internal RTC LDO application circuit 1

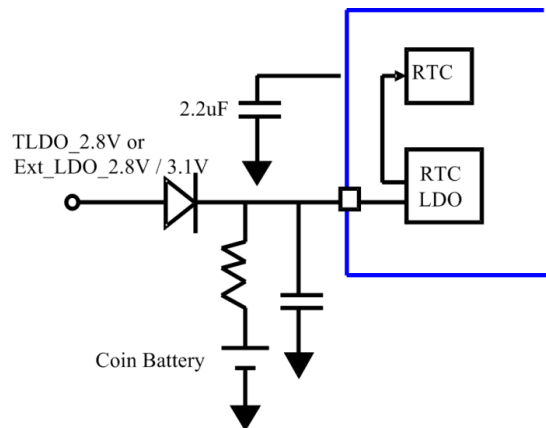


Figure 5-2: RTC with internal RTC LDO application circuit 2

5.3 SMPS

A built-in switching mode power supply provides 1.8 volts power supply for the digital 1.2 volts CLDO and RF input power. In the active mode, SMPS is operated in the PWM mode. In the power saving mode, SMPS is operated with reduced switching frequency in the PFM mode. The recommended L/C value is 4.7 uH / 10 uF.

5.4 Timer function

The timer function supports a time tick generation of 31.25 ms resolution. With the 24-bit counter, the period of timer is from 31.25 ms to 524,287 s. The “PAD_TIMER” pin outputs signal 1'b0 during the timer period and becomes an input pin after time-out. The power control function for the system can be executed by connecting this pin to an external LDO controller and adding external pull-high circuit.

5.5 GPIO in RTC domain

The “32K_OUT” pin in RTC domain can output 32.768 KHz clock which can be used to support low clock rate operation mode for some applications or peripherals that need an external clock source. This pin can also be programmed to be an input pin to receive the signal from an external accelerator sensor IC to be the wake-up signal of MT3337 when it is in the low-power mode.

5.6 Low power detection

A low power detection circuit is implemented. Whenever the independent power source (AVDD12_RTC) becomes low voltage, the low power detection circuit will detect this condition and use an indicator signal (output high in normal condition and low in low-power condition) to reflect this condition.

5.7 Clock module

The clock module generates all internal clocks required by processor, correlator, internal memory, bus interface and so on. The referenced input clock is generated from the RF block. For system flexibility and maximum power saving, it supports various power management modes.

5.8 Reset controller

The built-in reset controller generates reset signals for all digital blocks. It has power-on reset feature and hardware trapping function. The power-on reset level is 2.7 ± 0.1 volts. The software reset function for different circuit blocks are also included for flexible applications.

In Figure 5-4, the voltage drop time T_{drop_vbat} and T_{drop_cldo} depend on the capacitance connection of their power net. But $T_{drop_vbat} > T_{drop_cldo}$ should be guaranteed for the correct operation of reset behavior during power off sequence. It is strongly recommend using external LDOs without output discharged function or make sure $T_{drop_vbat} > 100$ ms.

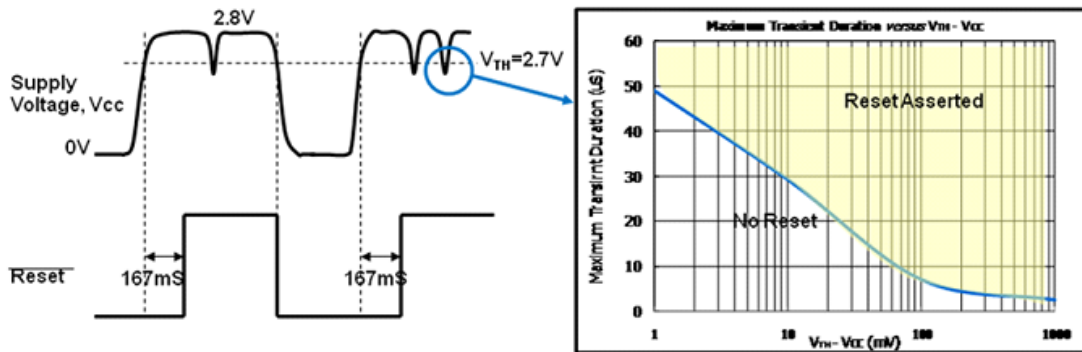


Figure 5-3: Power on reset diagram

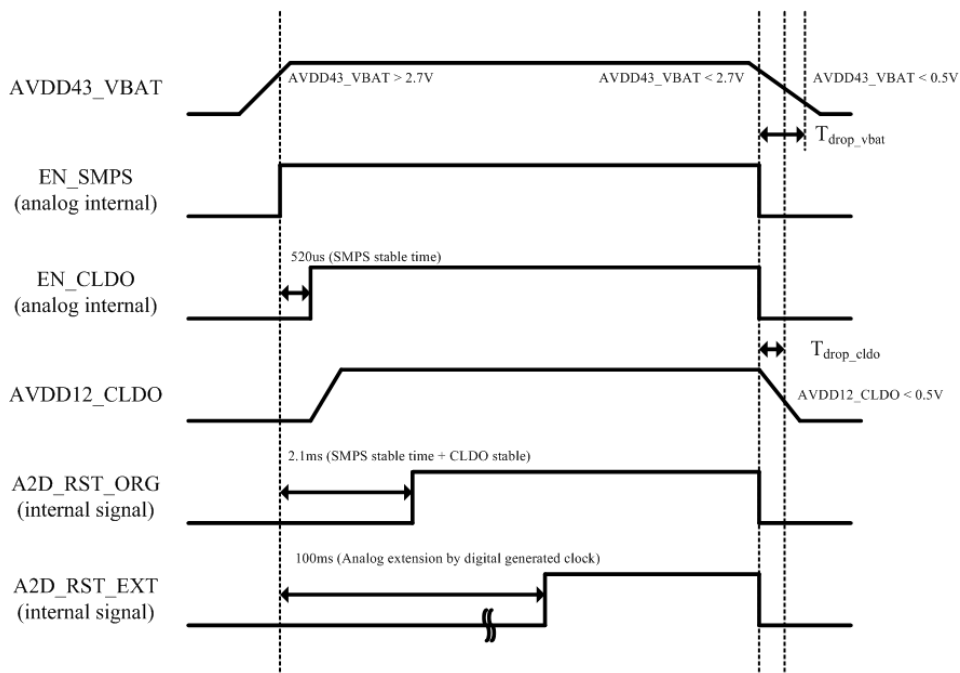


Figure 5-4: Power on/off reset behavior

5.9 Host interface

MT3337 supports 1 host interface, which is UART

5.9.1 UART

UART is the abbreviation of “Universal Asynchronous Receiver/Transmitter”. MT3337 has 3 full duplex serial ports. It is used for serial data communication. A UART converts bytes of data to and from asynchronous start-stop bit streams represented as binary electrical impulses.

There are several functions in MT3337 related to UART communication, such as UART data transmission/receive and NMEA sentences input/output. In general, UART0 is as NMEA output and PMTK command input, UART1 as RTCM input. You can adjust the UART2 port as desired. The receiver (RX) and transmitter (TX) side of every port contains a 16-byte FIFO, but only UART0 has 256 bytes of URAM. The bit rates are selectable from 4800, 9600, 38400, and 115200 bps. UART provides signal or message outputs.

5.10 Interrupt control unit

The interrupt control unit manages all internal and external sources of interrupts, which include timer, watch-dog, all interfaces such as UART, I2C and SPI and external user interrupt pins. These interrupt sources can be wake-up events in the power saving mode.

5.11 EFUSE

EFUSE is one of OTP (One-Time-Programming) memories. The internal EFUSE supports up to 128 bits for user configuration.

5.12 GPIO unit

GPIO is the abbreviation of “General-Purpose Input/Output”. MT3337 supports a variety of peripherals through maximum 16 GPIO programmable ports. The unit manages all GPIO lines and supports a simple control interface. GPIO provides signal or message outputs.

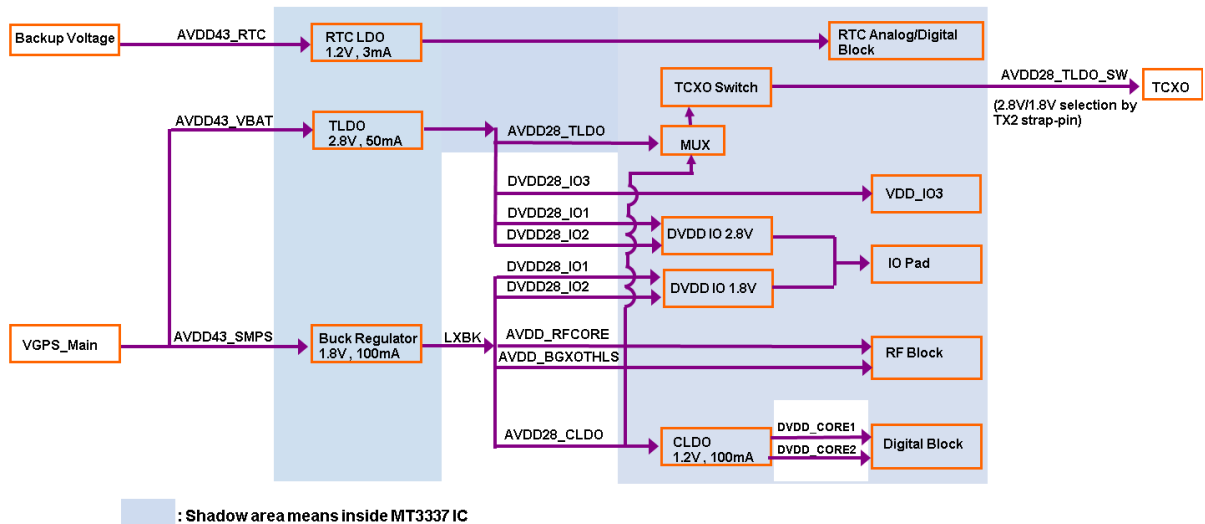
5.13 PPS

The PPS (Pulse Per Second) signal is provided through designated output pin for many external applications. The pulse is not only limited to being active every second but also allowed to set up the required duration, frequency and active high/low by programming user-defined settings.

5.14 Power scheme

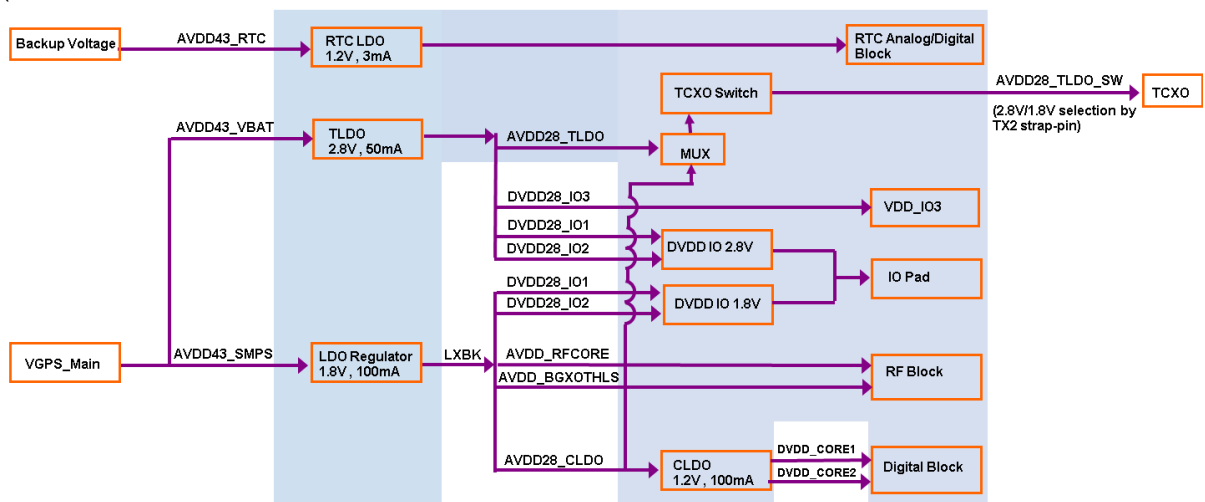
- Internal SMPS is used as the source power of the internal RF/BB LDO. It is also used as 1.8 volts I/O power. The internal SMPS can switch to the LDO mode to supply power to each of the about block
- External LDO or VBAT can be used as the main power. The minimum/maximum input voltage of AVDD43_VBAT and AVDD43_SMPS is 2.8/4.3 volts.

- The power-on reset voltage threshold of AVDD43_VBAT is 2.7 ± 0.1 volts. The maximum TLDO drop out voltage at half load (25 mA) is 0.25 volts. If one external LDO is used to provide power to MT3337, the 3.3 volts external LDO will be recommended after taking TLDO drop-out into consideration.
- The power efficiency in SMPS mode will be better than that in the internal LDO mode.
- I/O supports 1.8 and 2.8 volts. The power comes from SMPS output for 1.8 volts application or TLDO output (AVDD28_TLDO) for 2.8 volts application.
- TCXO power is from AVDD28_TLDO_SW that can select either from AVDD28_TLDO (2.8V) or from AVDD28_CLDO (1.8V) by setting up power-on strap.
- RTC LDO input power comes from backup battery or uses coin battery.
- Here are 3 power schemes: low power (



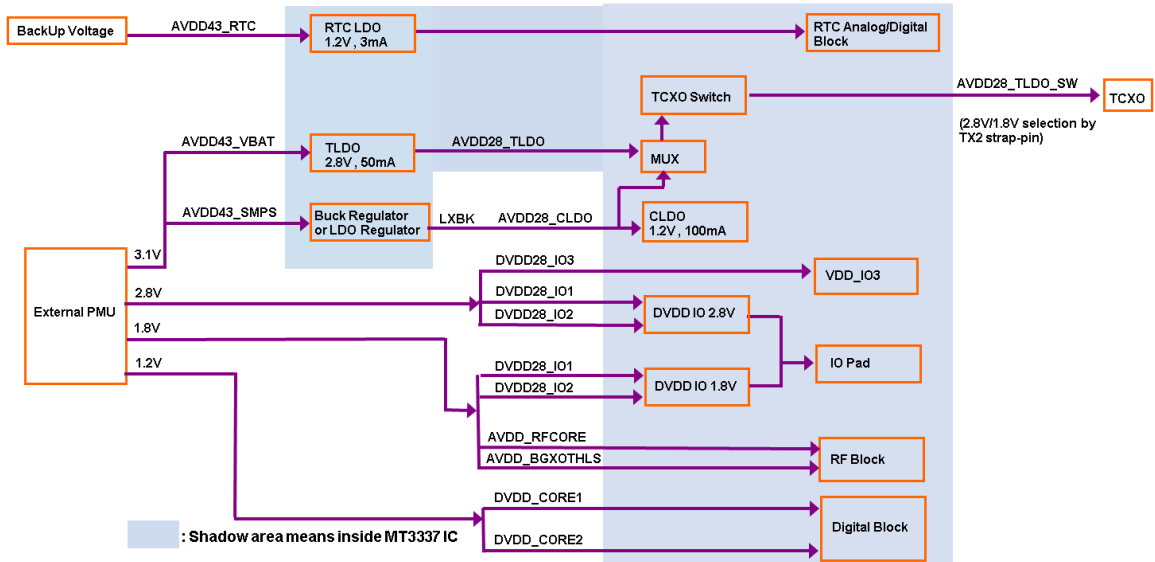
: Shadow area means inside MT3337 IC

- Figure 5-5), low cost (

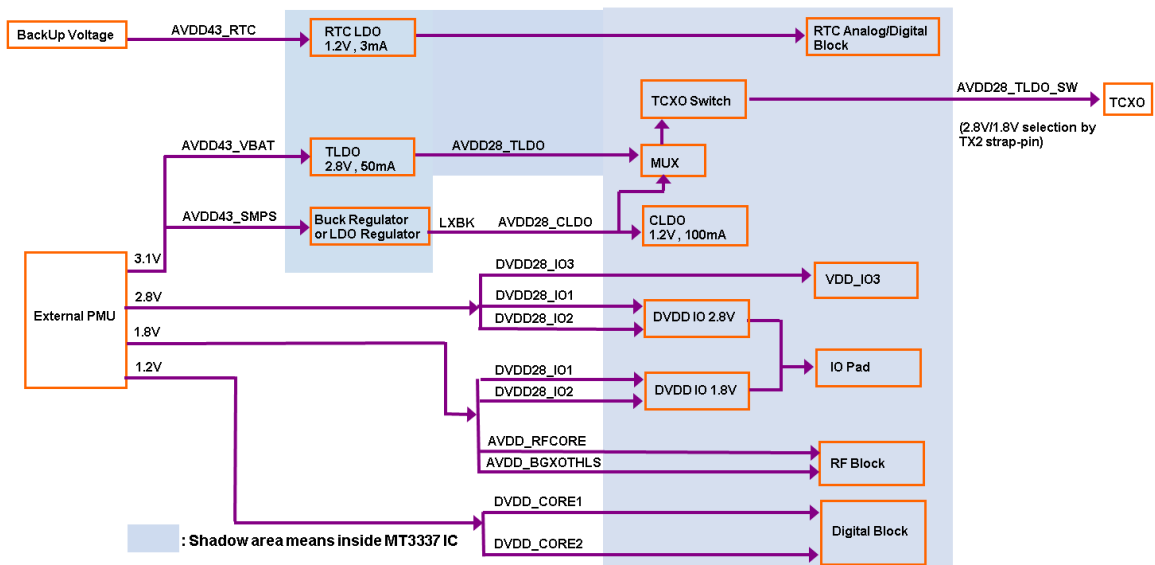


: Shadow area means inside MT3337 IC

- Figure 5-6) and external PMU



- Figure 5-7).
- In



- Figure 5-7, if 2.8V TCXO is used, AVDD28_CLDO should be open for saving power.

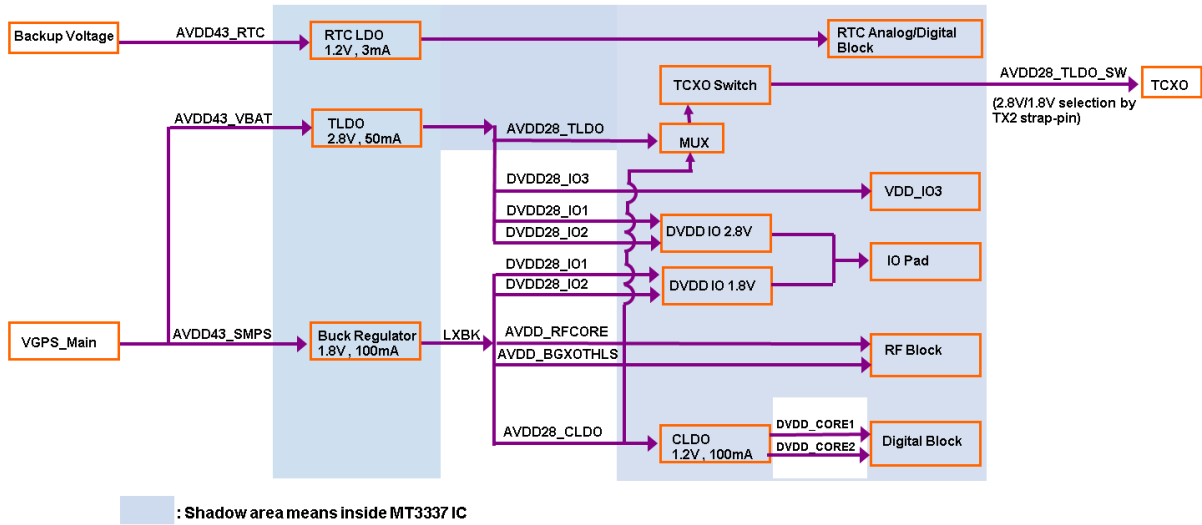


Figure 5-5: Power supply connection (low power)

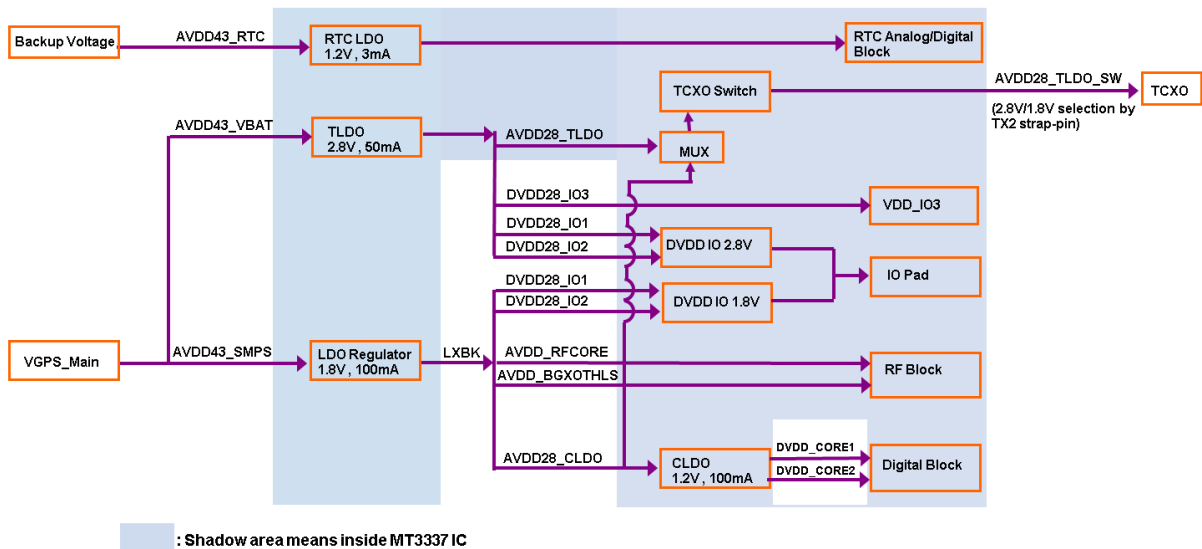


Figure 5-6: Power supply connection (low cost)

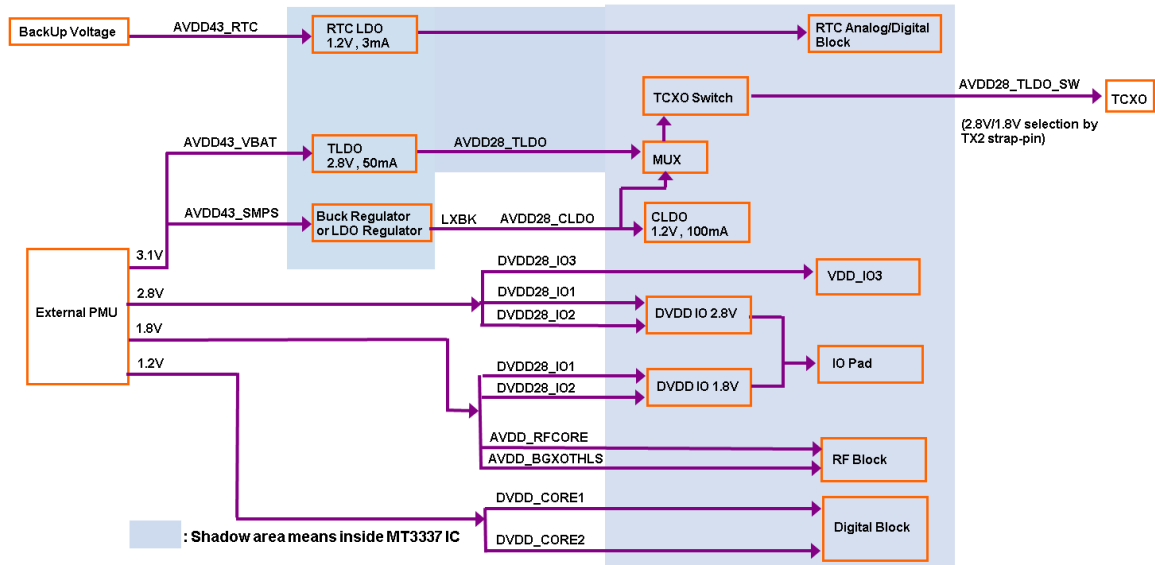


Figure 5-7: Power supply connection (external LDO)

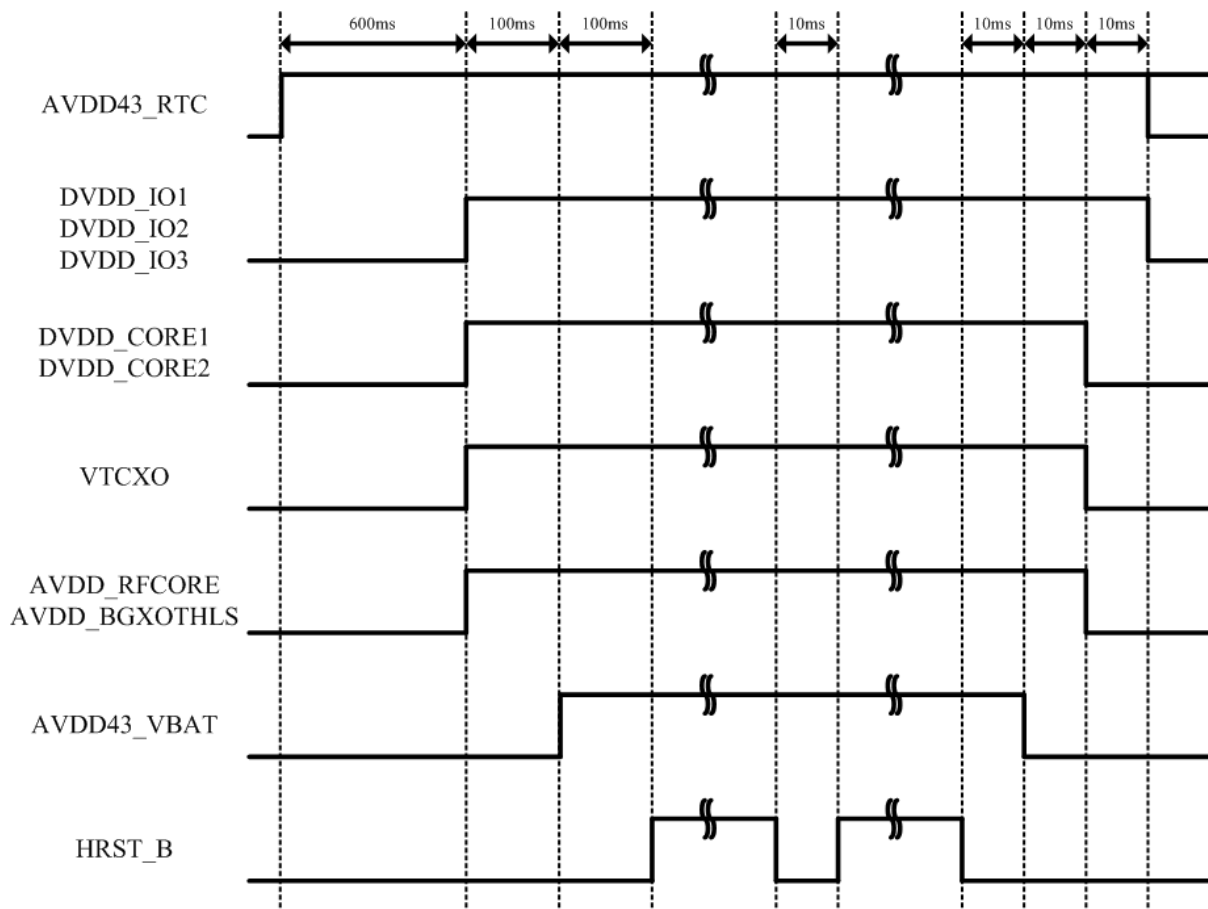


Figure 5-8: Power on/off sequence for external LDO mode

6 Electrical Characteristics

6.1 DC characteristics

6.1.1 Absolute maximum ratings

Symbol	Parameter	Rating	Unit
AVDD43_SMPS	SMPS power supply	-0.3 ~ 4.3	V
AVDD43_VBAT	2.8 volts TLDO power supply	-0.3 ~ 4.3	V
AVDD28_CLDO	1.2 volts CLDO power supply	-0.3 ~ 3.08	V
DVDD_IO1 DVDD_IO2 DVDD_IO3	IO 2.8/1.8 volts power supply	-0.3 ~ 3.6	V
DVDD_CORE1 DVDD_CORE2	Baseband 1.2 volts power supply	-0.3 ~ 1.32	V
AVDD43_RTC	RTC 1.2 volts LDO power supply	-0.3 ~ 4.3	V
AVDD_RFCORE	1.8 volts supply for RF core circuits	-0.3 ~ 3.08	V
AVDD_BGXOTHLS		-0.3 ~ 3.08	V
T _{STG}	Storage temperature	-50 ~ +125	°C
T _A	Operating temperature	-45 ~ +85	°C

6.1.2 Recommended operating conditions

Symbol	Parameter	Min.	Typ.	Max.	Unit
AVDD43_SMPS	SMPS power supply	2.8	3.3	4.3	V
AVDD43_VBAT	2.8 volts TLDO power supply	2.8	3.3	4.3	V
DVDD_CORE1 DVDD_CORE2	1.2 volts baseband core power	1.08	1.2	1.32	V
DVDD_IO1 DVDD_IO2 DVDD_IO3	2.8 volts digital I/O power	2.52	2.8	3.08	V
	1.8 volts digital I/O power	1.62	1.8	1.98	V
AVDD_RFCORE	1.2 volts supply for RF core circuits in bypass mode	1.16	1.2	1.26	V
	1.8 volts supply for RF core circuits in LDO mode	1.62	1.8	3.08	V
AVDD_BGXOTHLS		1.62	1.8	3.08	V
T _A T _j	Operating temperature	-40	25	85	°C
	Commercial junction operating temperature	0	25	115	°C
	Industry junction operating temperature	-40	25	125	°C

6.1.3 General DC characteristics

Symbol	Parameter	Condition	Min.	Max.	Unit
I _{IL}	Input low current	No pull-up or down	-1	1	uA
I _{IH}	Input high current	No pull-up or down	-1	1	uA
I _{OZ}	Tri-state leakage current		-10	10	uA

6.1.4 DC electrical characteristics for 2.8 volts operation

Symbol	Parameter	Condition	Min.	Max.	Unit
V _{IL}	Input lower voltage	LVTTTL	-0.3	0.8	V
V _{IH}	Input high voltage		2.0	3.6	V
V _{T-}	Schmitt trigger negative going threshold voltage	LVTTTL	0.8	1.6	V
V _{T+}	Schmitt trigger positive going threshold voltage		1.6	2.0	V
V _{OL}	Output low voltage	I _{OL} = 1.6 ~ 14 mA	-0.3	0.4	V
V _{OH}	Output high voltage	I _{OH} = 1.6 ~ 14 mA	2.4	VDD28 + 0.3	V
R _{PU}	Input pull-up resistance	PU = high, PD = low	40	190	KΩ
R _{PD}	Input pull-down resistance	PU = low, PD = high	40	190	KΩ

6.1.5 DC electrical characteristics for 1.8 volts operation

Symbol	Parameter	Condition	Min.	Max.	Unit
V _{IL}	Input lower voltage	LVTTL	-0.18	0.4	V
V _{IH}	Input high voltage		1.5	1.98	V
V _{T-}	Schmitt trigger negative going threshold voltage	LVTTL	0.44	0.88	V
V _{T+}	Schmitt trigger positive going threshold voltage		0.88	1.1	V
V _{OL}	Output low voltage	I _{OL} = 1.6 ~ 14 mA	-0.18	0.4	V
V _{OH}	Output high voltage	I _{OH} = 1.6 ~ 14 mA	1.4	VDD18 + 0.18	V
R _{PU}	Input pull-up resistance	PU = high, PD = low	40	190	KΩ
R _{PD}	Input pull-down resistance	PU = low, PD = high	40	190	KΩ

6.1.6 DC electrical characteristics for 1.2 volts operation (for TIMER and 32K_OUT)

Symbol	Parameter	Condition	Min.	Max.	Unit
V _{IL}	Input lower voltage	LVTTL	-0.3	0.54	V
V _{IH}	Input high voltage		0.66	3.6	V
V _{T-}	Schmitt trigger negative going threshold voltage	LVTTL	0.24	0.46	V

Symbol	Parameter	Condition	Min.	Max.	Unit
V _{T+}	Schmitt trigger positive going threshold voltage		0.64	0.9	V
V _{OL}	Output low voltage	I _{OL} = 0.9 mA		0.42	V
V _{OH}	Output high voltage	I _{OH} = 0.9 mA	0.78		V
R _{PU}	Input pull-up resistance	PU = high, PD = low	130	560	KΩ
R _{PD}	Input pull-down resistance	PU = low, PD = high	130	560	KΩ

6.2 Analog related characteristics

6.2.1 SMPS DC characteristics

Symbol	Parameter	Min.	Typ.	Max.	Unit	Note
AVDD43_SMPS	SMPS input supply voltage	2.8	3.3	4.3	V	
LXBK	SMPS output	1.71	1.8	1.95	V	
I _{max}	SMPS current limit	100			mA	
I _{cc}	For normal operation current		20	70	mA	
ΔV_PWM	Ripple of PWM mode			40	mV	With L=4.7uH, C=10uF
ΔV_PFM	Ripple of PFM mode			90	mV	With L=4.7uH, C=10uF
I _q	Quiescent current		50		uA	

6.2.2 TCXO LDO DC characteristics

Symbol	Parameter	Min.	Typ.	Max.	Unit	Note
AVDD43_VBAT	TCXO LDO input supply voltage	2.8	3.3	4.3	V	Will change to bypass mode under 3.1 volts
AVDD28_TLDO	TCXO LDO output	2.7	2.8	2.9	V	
I _{max}	TCXO LDO current limit	50			mA	
I _{cc}	For normal operation current		1	30	mA	Not include external devices
	PSRR-30 KHz		40		dB	Co = 1 uF, ESR = 0.05, Iload = 25 mA
	Load regulation		10		mV	
I _q	Quiescent current		50		uA	

6.2.3 TCXO SWITCH DC characteristics

Symbol	Parameter	Min.	Typ.	Max.	Unit	Note
AVDD28_TLDO_SW	TCXO switch output voltage @ TCXO switch input = AVDD28_TLDO	2.66	2.8	2.9	V	

Symbol	Parameter	Min.	Typ.	Max.	Unit	Note
AVDD28_TLDO_SW	TCXO switch output voltage @ TCXO switch input = AVDD28_CLDO	1.71	1.8	1.89	V	
I _{max}	TCXO SWITCH current limit	2			mA	

6.2.4 1.2 volts core LDO DC characteristics

Symbol	Parameter	Min.	Typ.	Max.	Unit	Note
AVDD28_CLDO	1.2 volts LDO input supply voltage	1.62	1.8	3.08	V	
AVDD12_CLDO	1.2 volts LDO output	1.1	1.2	1.3	V	
I _{max}	1.2 volts LDO current limit	100			mA	
I _{cc}	For normal core operation current		15	85	mA	
	Load regulation		10		mV	
I _q	Quiescent current		20		uA	

6.2.5 1.2 volts RTC LDO DC characteristics

Symbol	Parameter	Min.	Typ.	Max.	Unit	Note
AVDD43_RTC	RTC LDO input supply voltage	2	2.8	4.3	V	
AVDD12_RTC	RTC LDO output	1.08	1.2	1.32	V	
I _{max}	RTC LDO current limit	3			mA	
I _{cc}	For normal RTC operation current			2.7	mA	
I _q	Quiescent current		2		uA	
I _{leak}	Leakage current		10		uA	Including LDO and RTC domain circuit

6.2.6 32 KHz crystal oscillator (XOSC32)

Symbol	Parameter	Min.	Typ.	Max.	Unit	Note
AVDD12_RTC	Analog power supply	1.08		1.32	V	
Dcyc	Duty cycle		50		%	

6.3 RF related characteristics

6.3.1 DC electrical characteristics for RF part

Symbol	Parameter	Min.	Typ.	Max.	Unit
I _{cc}	Total supply current: High gain LNA		13.5	14.8	mA

Symbol	Parameter	Min.	Typ.	Max.	Unit
	Total supply current: Middle gain LNA Total supply current: Low gain LNA (Total supply current = RX + SX + LDO current)		8.5 7.3	9.4 8	
I _{cc} (STAND-BY)	Only the PLL, oscillator and regulator are kept powered up.		3.5		mA
I _{cc} (DOZE)	Only the oscillator and regulator are kept powered up.		0.6		mA
I _{cc} (Off)	Power-down state current			2	μA

6.3.2 RX chain from LNA to PGA, before ADC

Parameter	Condition	Min.	Typ.	Max.	Unit
Noise figure	SOC on: High gain LNA SOC on: Mid gain LNA SOC on: Low gain LNA		2 2.5 5.5	2.5 3 6	dB
Image rejection ratio			30		dB
V _{cc}		1.16	1.2	1.26	V
Current consumption	RX chain only (LNA, mixer, CSF, PGA, divider, ADC)		5.5		mA

6.3.3 Receiver front-end part (LNA only)

Parameter	Condition	Min.	Typ.	Max.	Unit
RF input frequency			1.57542		GHz
LO frequency			1.57132		GHz
Input return loss			-10		dBm
Voltage gain -- Av	High gain LNA Mid gain LNA Low gain LNA	27.5 25.5 16	29 27 18		dB
Noise figure	High gain LNA Mid gain LNA Low gain LNA		1.5 2 5	2 2.5 6	dB

6.3.4 Mixer and channel selection filter (CSF)

Parameter	Condition	Min.	Typ.	Max.	Unit
Filter type	3 rd -order butterworth polyphase bandpass (Note 1)				
Voltage	Supply voltage	1.16	1.2	1.26	V
BW _{3dB}	3dB bandwidth		2.5/4		MHz
Filter frequency response (2.5M/4M)	Rejection band attenuation @ f = 3 MHz @ f = 10 MHz @ f = 15 MHz @ f > 20 MHz		23/12 54/45 65/54 72/60		dB

Voltage gain -- Av	High gain mixer + CSF Low gain mixer + CSF		32 20		dB
--------------------	---	--	----------	--	----

6.3.5 Programmable gain amplifier (PGA)

Parameter	Condition	Min.	Typ.	Max.	Unit
Supply voltage	Supply voltage	1.16	1.2	1.26	V
Center frequency	Centre frequency		4.092		MHz
Voltage gain	Voltage gain	0		40	dB
Gain step	Gain step (5 bits)		1.6		dB

6.3.6 2-bit and 4-bit quantizer (ADC)

Parameter	Condition	Min.	Typ.	Max.	Unit
Supply voltage	Supply voltage	1.16	1.2	1.26	V
Input sampling clock	Operating frequency		16.368	30	MHz
Input signal frequency	Input signal center frequency		4.092		MHz
Resolution			4		Bits

6.3.7 Integrated synthesizer

Symbol	Parameter	Min.	Typ.	Max.	Unit
F _{osc}	VCO oscillation frequency		3,142.6 56		MHz
V	Tuning voltage range	0.2		V _{cc} -0.2	V
DIV	Programmable divider ratio	32		127	
T _{start}	Circuit start-up time			100	μs

6.3.8 Crystal oscillator (XO)

Symbol	Parameter	Min.	Typ.	Max.	Unit
F _{tcxo}	TCXO oscillation frequency	-	16.368	-	MHz
		-	26	-	
V _{tcxo}	TCXO output swing	0.8	1.2		V _{pp}

7 Interface Characteristics

7.1 JTAG interface timing

Description	Symbol	Min.	Max.	Unit	Note
TDI input setup to rising TCK	T1	0.35T	-	ns	1
TDI input hold from rising TCK	T2	0.15T	-	ns	1
TMS input setup to rising TCK	T1	0.35T	-	ns	1
TMS input hold from rising TCK	T2	0.15T	-	ns	1
Rising TCK to TDO valid	T3	-	0.5T	ns	1
TDO hold from rising TCK	T4	0	-	ns	1

Note: The maximal condition of JTAG clock cycle (TCK) is 50 MHz.

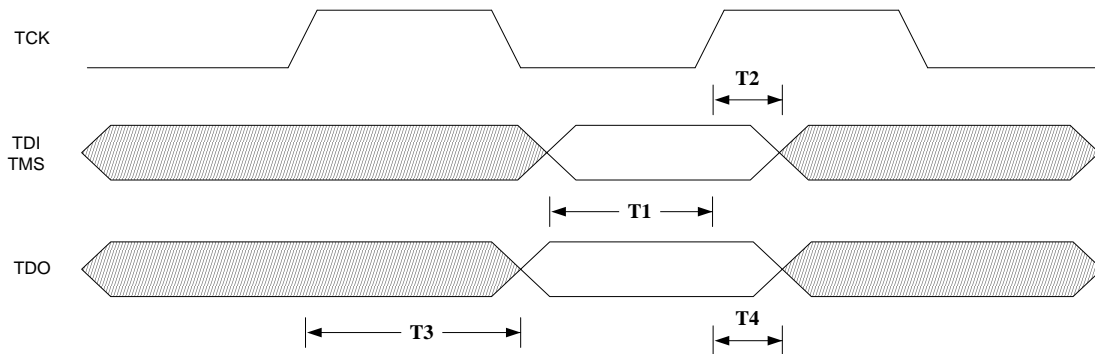


Figure 7-1: Timing diagram of JTAG interface

7.2 RS-232 interface timing

Baudrate required (bps)	Programmed baudrate (bps)	Baudrate error (%)	Baudrate error (%) ³
4,800	4,800.000	0.0000	0.002
9,600	9,600.000	0.0000	0.002
38,400	38,422.535	0.0587	0.0567
115,200	115,267.606	0.0587	0.0567

Notes:

1. UART baud-rate settings with UART_CLK frequency = 16.368 MHz (UART_CLK uses the reference clock of the system).
2. The baudrate error is optimized. Each baudrate needs to adjust counter to obtain the optimized error.
3. Suppose TCXO is exactly at 16.368 MHz. If TCXO has 20 PPM, the error will raise slightly.

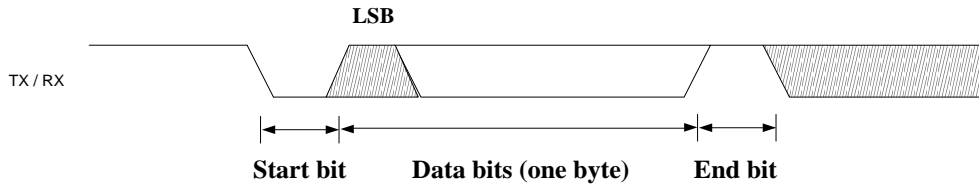


Figure 7-2: Timing diagram of RS-232 interface

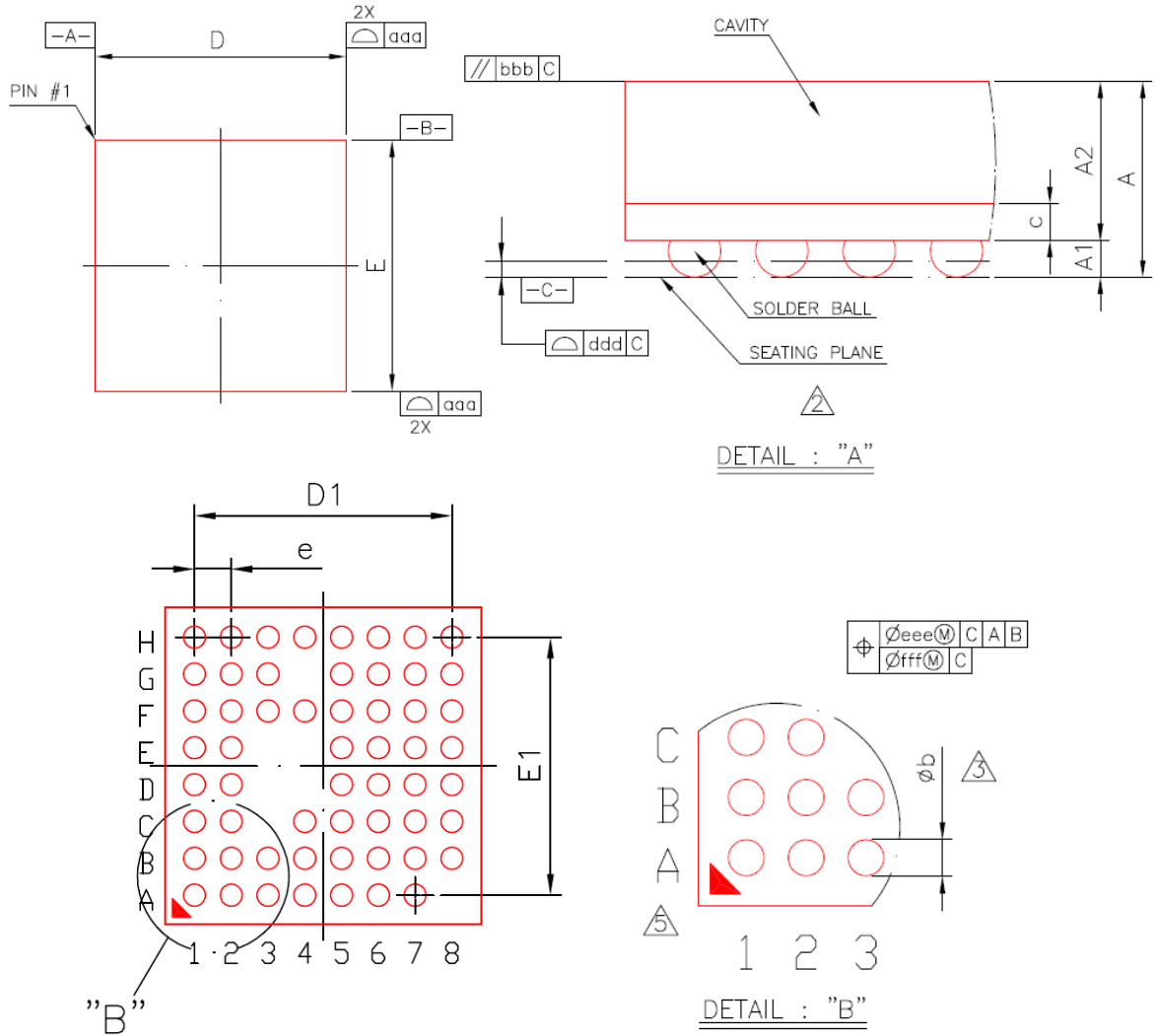
8 Package Description

8.1 Top mark

MTK ARM 3337V DDDDDD LLLLLL FFFFFF •

V : VFBGA package
DDDDDD : Date code
LLLLLL : U1 Lot number
FFFFFF : U2 Lot number

8.2 Package dimensions



Symbol	Dimension in mm			Dimension in inch		
	MIN	NOM	MAX	MIN	NOM	MAX
A	---	---	1.00	---	---	0.039
A1	0.16	0.21	0.26	0.006	0.008	0.010
A2	0.69	0.74	0.79	0.027	0.029	0.031
c	0.17	0.21	0.25	0.007	0.008	0.010
D	4.20	4.30	4.40	0.165	0.169	0.173
E	4.20	4.30	4.40	0.165	0.169	0.173
D1	---	3.50	---	---	0.138	---
E1	---	3.50	---	---	0.138	---
e	---	0.50	---	---	0.020	---
b	0.25	0.30	0.35	0.010	0.012	0.014
aaa	0.10			0.004		
bbb	0.10			0.004		
ddd	0.08			0.003		
eee	0.15			0.006		
fff	0.05			0.002		
MD/ME	8/8			8/8		

NOTE :

1. CONTROLLING DIMENSION : MILLIMETER.
- ① PRIMARY DATUM C AND SEATING PLANE ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.
- ③ DIMENSION b IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER, PARALLEL TO PRIMARY DATUM C.
4. SPECIAL CHARACTERISTICS C CLASS: bbb, ddd
- ⑤ THE PATTERN OF PIN 1 FIDUCIAL IS FOR REFERENCE ONLY.

**ESD CAUTION**

MT3337 is ESD (electrostatic discharge) sensitive device and may be damaged with ESD or spike voltage. Although MT3337 is with built-in ESD protection circuitry, please handle with care to avoid permanent malfunction or performance degradation.

Use of the GPS Data and Services at the User's Own Risk

The GPS data and navigation services providers, system makers and integrated circuit manufactures ("Providers") hereby disclaim any and all guarantees, representations or warranties with respect to the Global Positioning System (GPS) data or the GPS services provided herein, either expressed or implied, including but not limited to, the effectiveness, completeness, accuracy, fitness for a particular purpose or the reliability of the GPS data or services.

The GPS data and services are not to be used for safety of life applications, or for any other application in which the accuracy or reliability of the GPS data or services could create a situation where personal injury or death may occur. Any use there with are at the user's own risk. The Providers specifically disclaims any and all liability, including without limitation, indirect, consequential and incidental damages, that may arise in any way from the use of or reliance on the GPS data or services, as well as claims or damages based on the contravention of patents, copyrights, mask work and/or other intellectual property rights.

No part of this document may be copied, distributed, utilized, and transmitted in any form or by any means without expressed authorization of all Providers. The GPS data and services are in part or in all subject to patent, copyright, trade secret and other intellectual property rights and protections worldwide.

MediaTek reserves the right to make change to specifications and product description without notice.